

Fig. 1

20F10

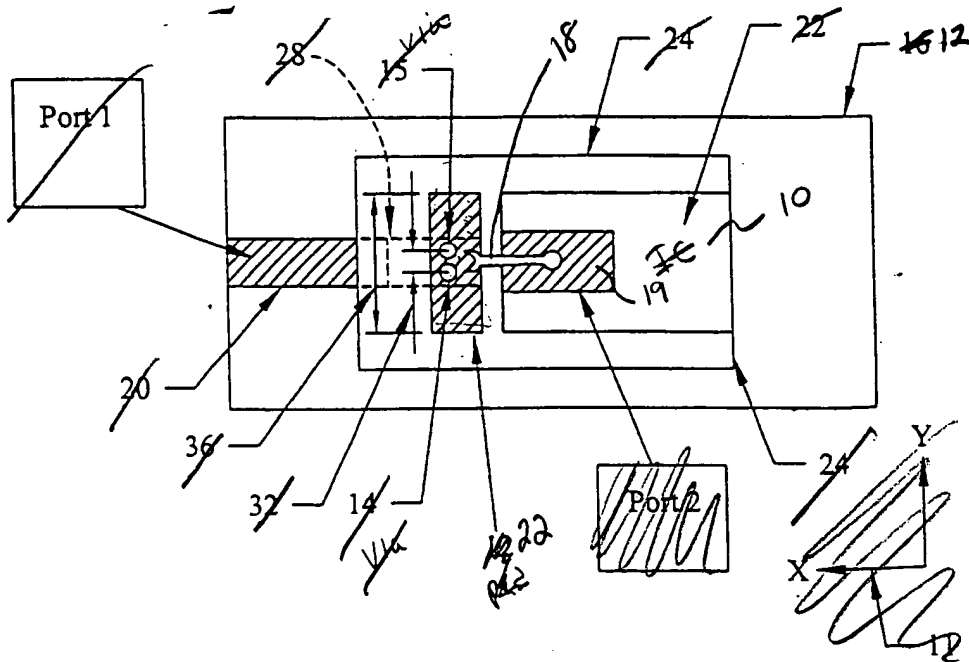
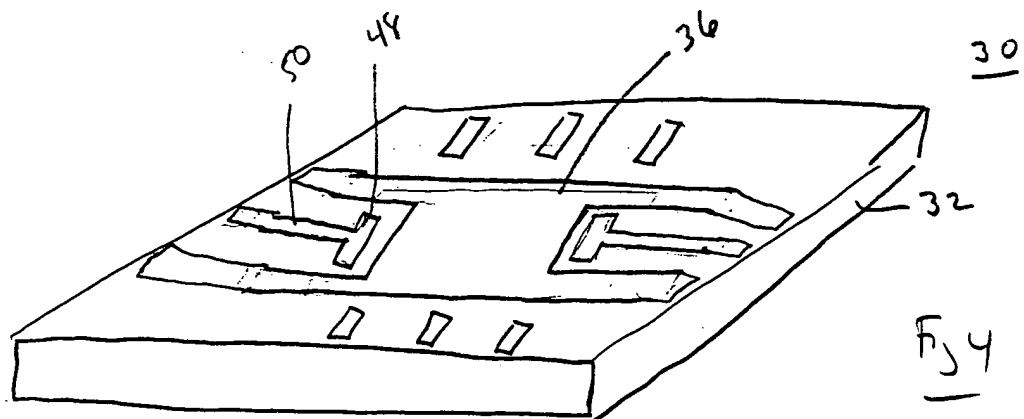
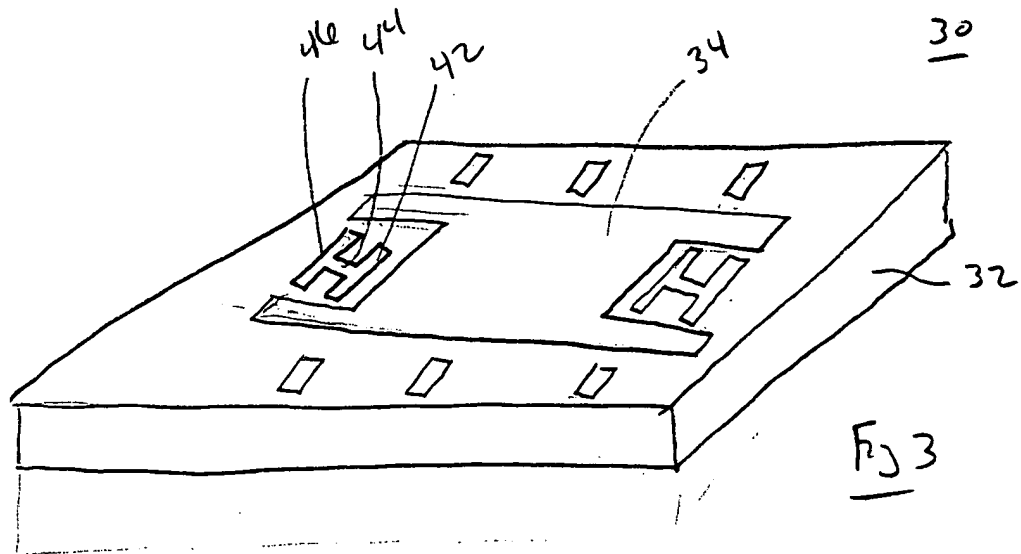
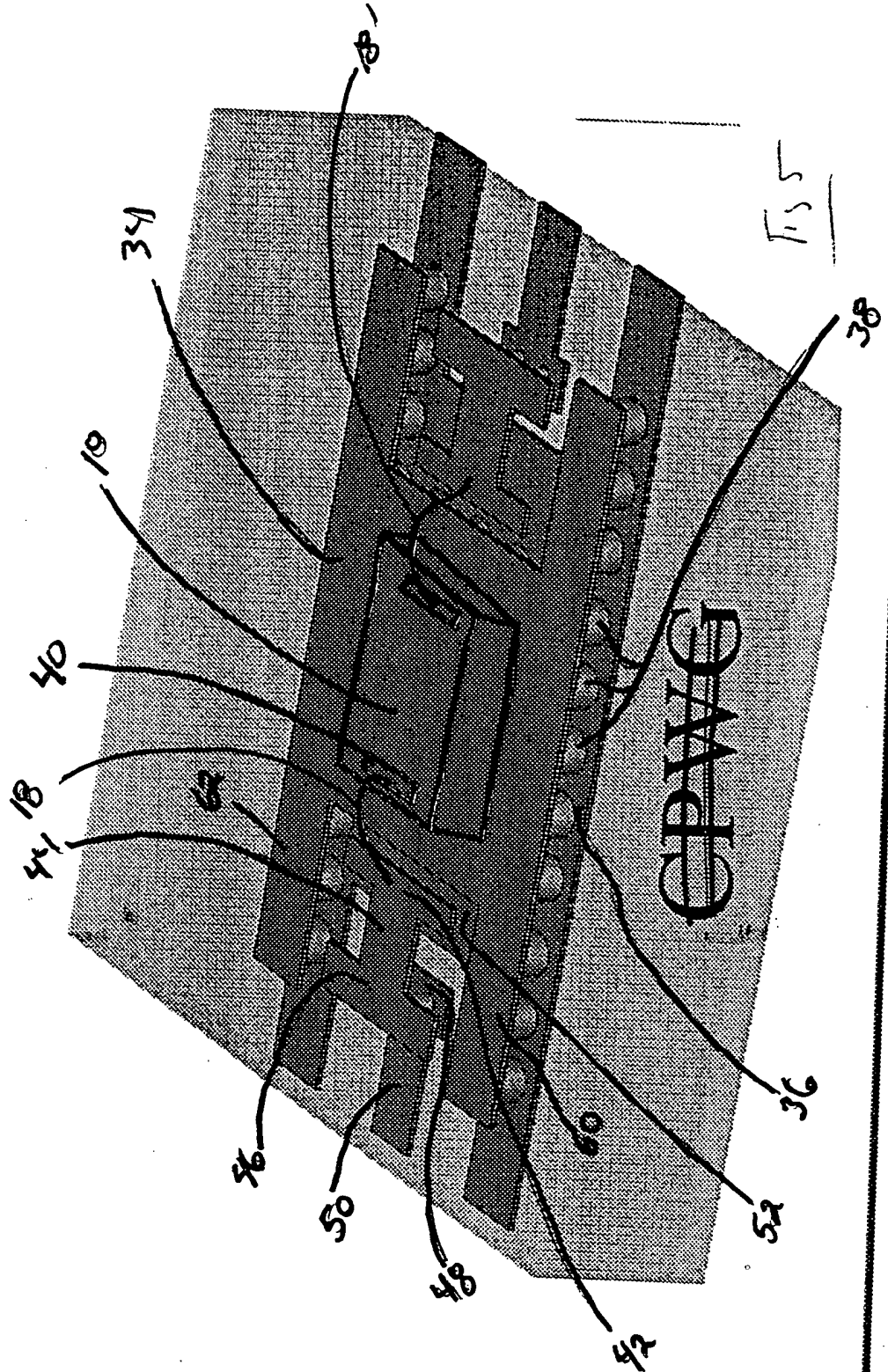


Fig. 2
(PRIOR ART)

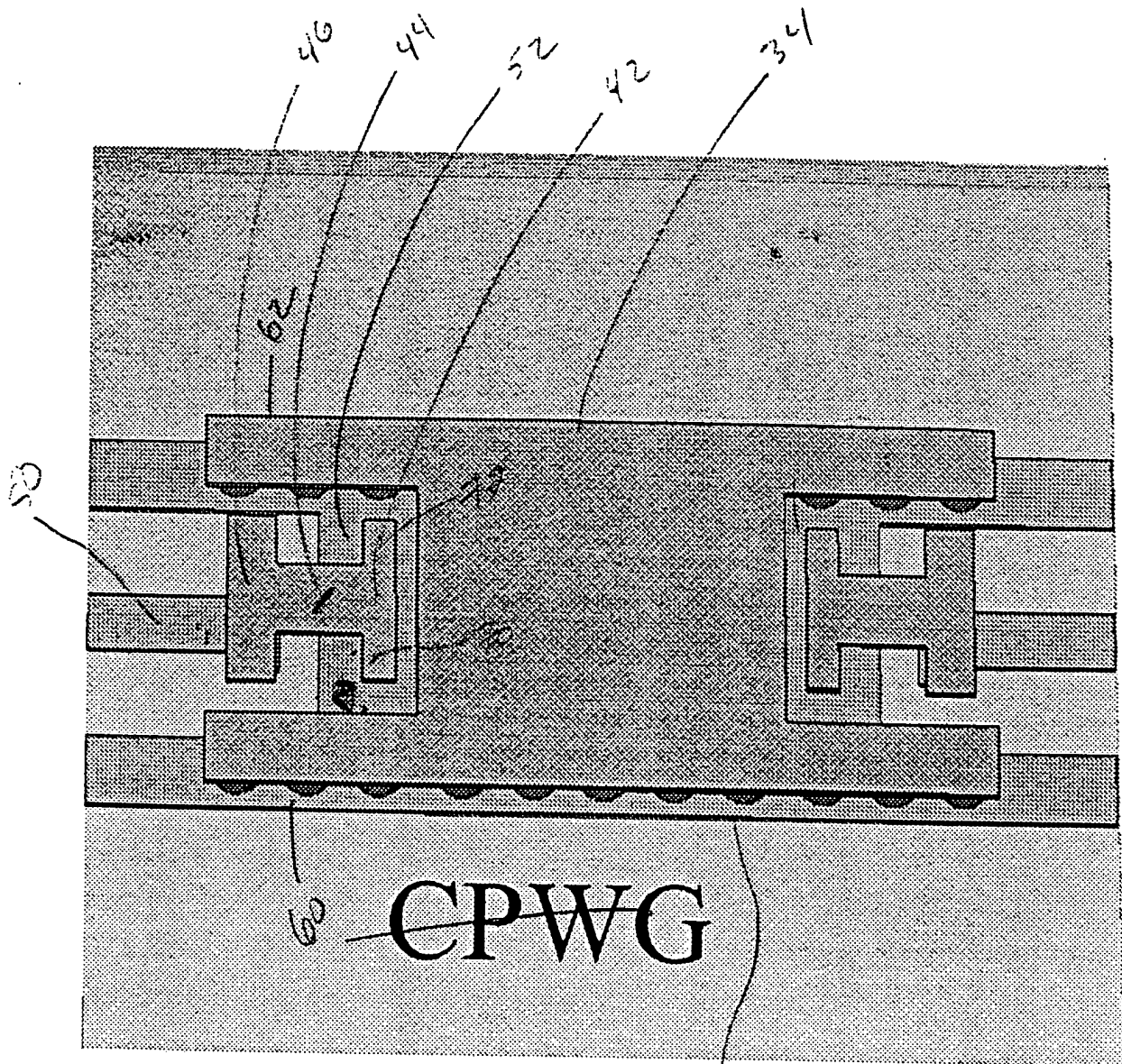
30F10



4 of 10



50F10



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~~Comp:~~

60F10

6. 50 Ohm line on top of carrier and on top of probable eval board (trimmed matching and single bond wire):

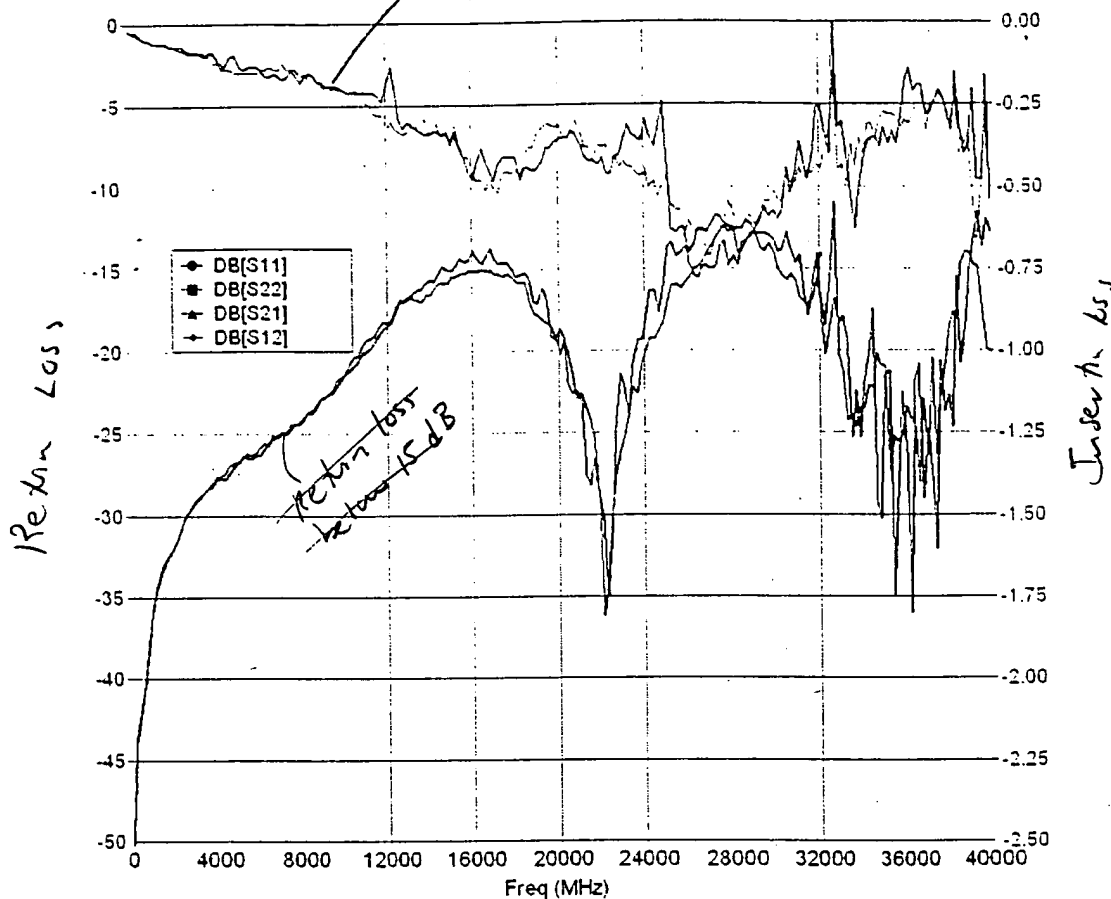
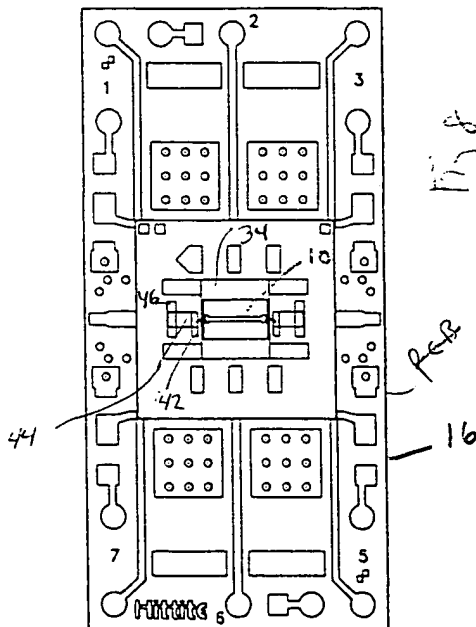
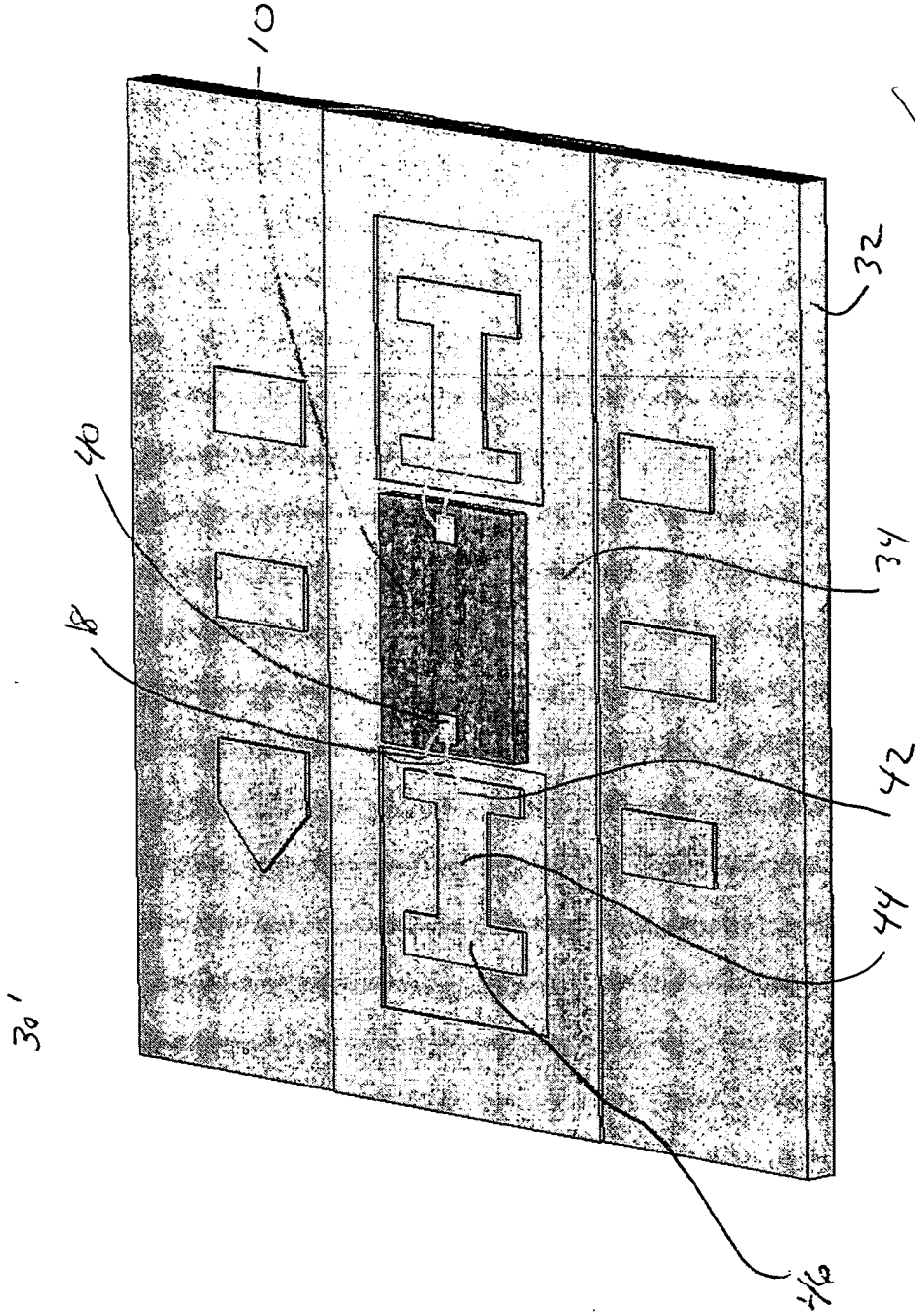


Fig 7



1/09/2004

Screenshot



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Page 7 of 10

Fig. 9

70F10

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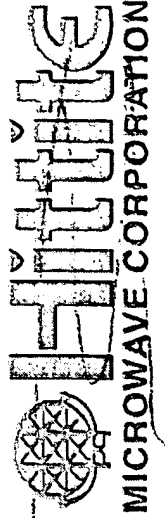
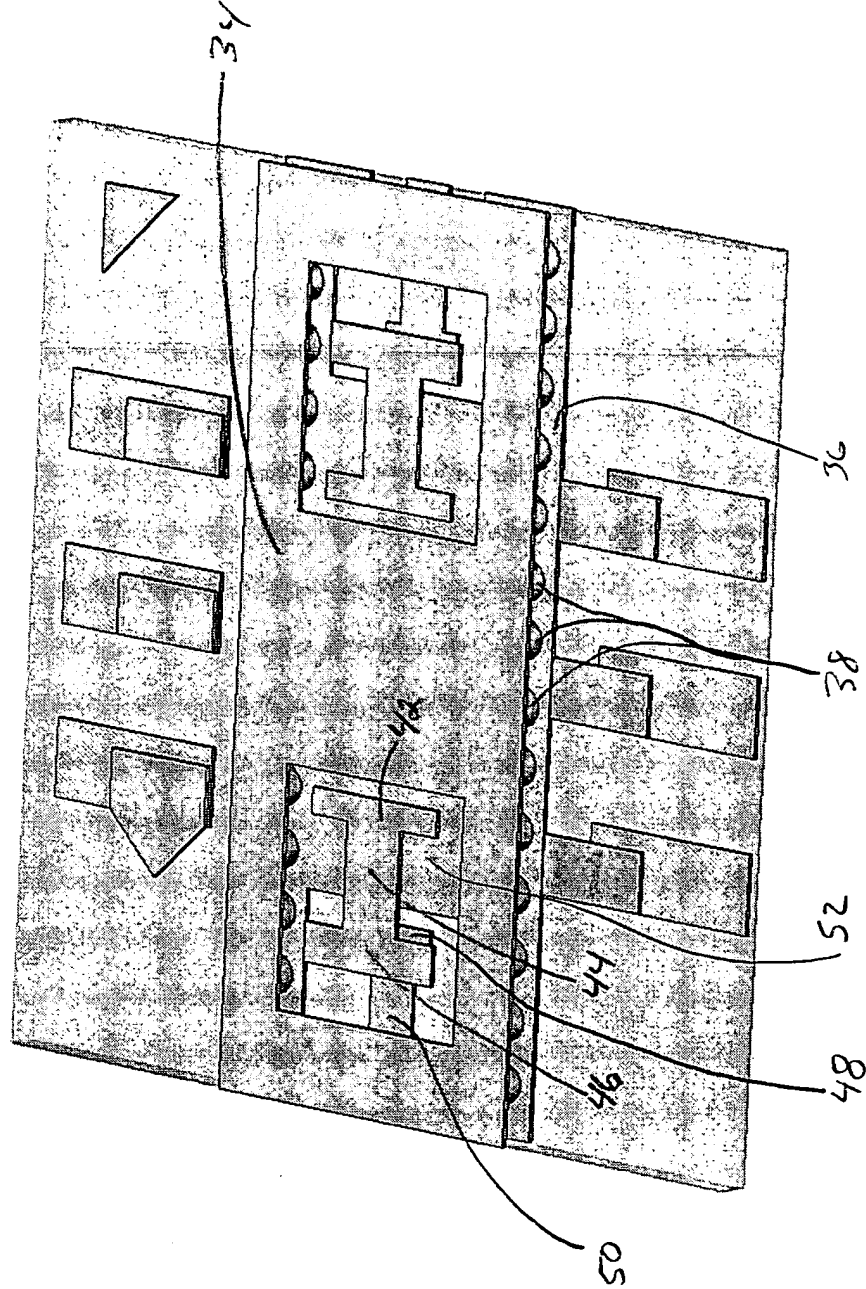
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Page 8 of 10

8 of 10

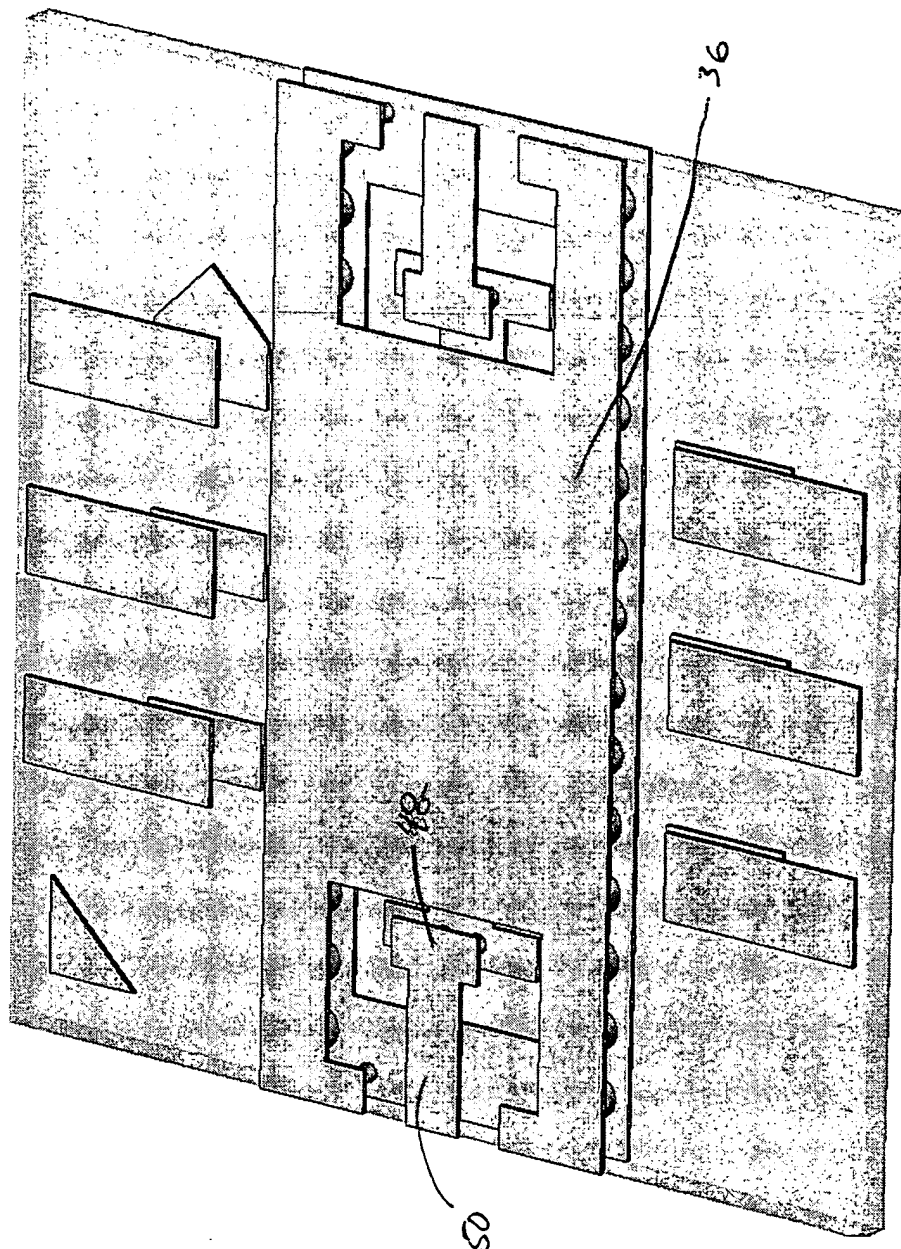
F310



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Page 9 of 10

93F10

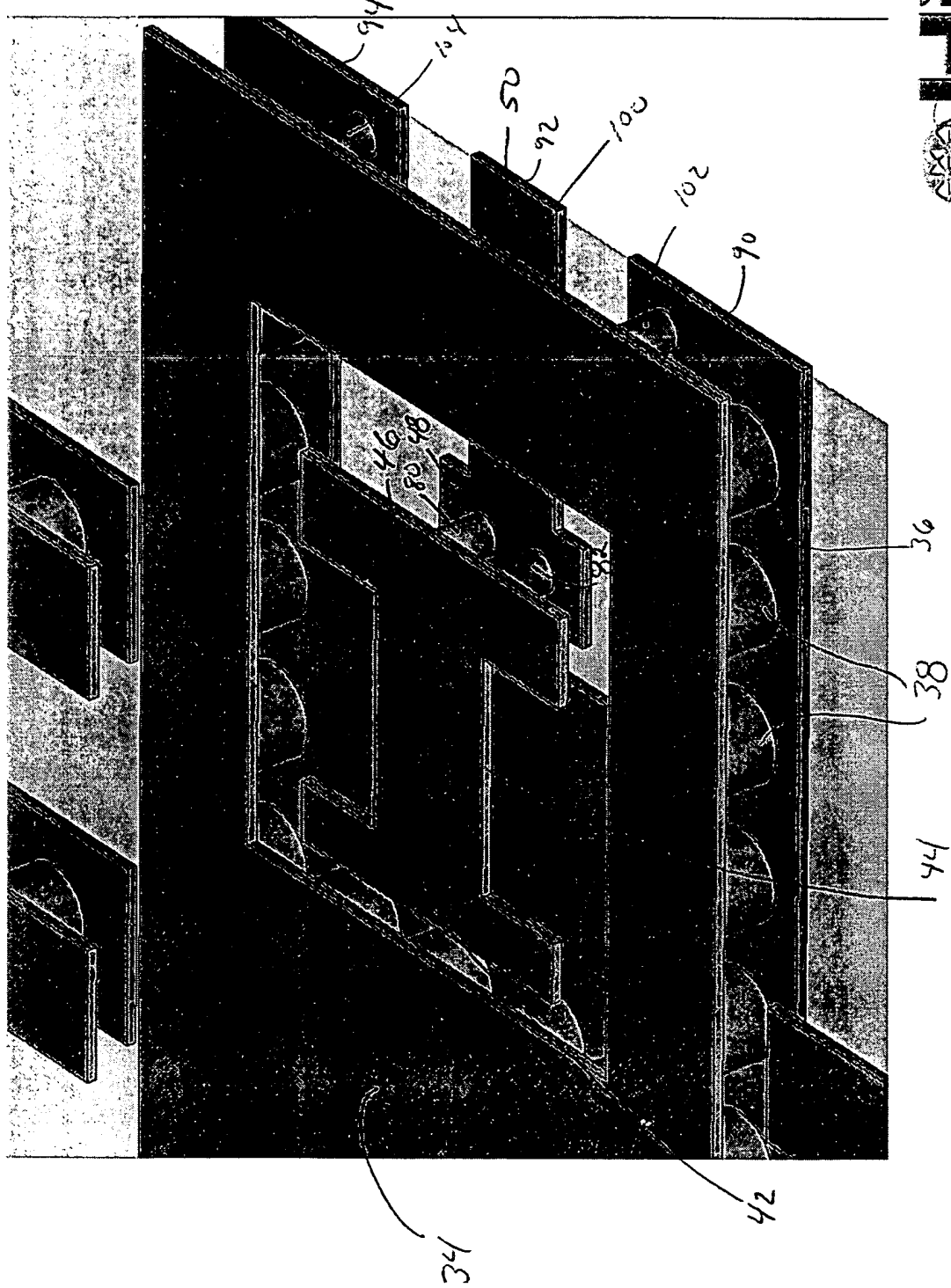
F311

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Page 10 of 10

10 OF 10

1512

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8